INFORMATION DISCLOSURE STATEMENT

Applicant

Kripesh et al.

App. No.

10/078,243

Filed

February 14, 2002

For

PROCESS OF FORMING METAL

SURFACES COMPATIBLE WITH A WIRE

BONDING AND SEMICONDUCTOR

INTEGRATED CIRCUITS

MANUFACTURED BY THE PROCESS

Examiner

L. A Gurley

Group Art Unit

2812

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Enclosed is form PTO-1449 listing three references that are also enclosed.

This Information Disclosure Statement is being filed under 37 C.F.R. § 1.97(c)(2) before the mailing date of a final action and before the mailing of a Notice of Allowance. This Statement is accompanied by the fees set forth in 37 C.F.R. § 1.17(p). The Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

Respectfully submitted,

By:

KNOBBE, MARTENS, OLSON & BEAR, LLP

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John M. Carson Registration No. 34,303

Attorney of Record Customer No. 20,995

(619) 235-8550

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U.S. PATENT DOCUMENTS									
EXAMINER INITIAL		DOCUMENT NUMBER	DATE		NAME	CLA	ss	SUBCLASS	FILING DATE (IF APPROPRIATE)
	1	5,659,201	8/19/1997	Wollesen					
	2	5,851,925	12/22/1998	Beh et al.					
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FOREIGN PATENT DOCUMENTS									
EXAMINER		DOCUMENT NUMBER	DATE		COUNTRY	CLASS	SUBCLASS	TRANSLATION	
INITIAL								YES	NO
	3	0 089 604	9/28/1993	EP					
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OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)							
 							
2	OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT P						

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EXAMINER

DATE CONSIDERED

*EXAMINER: INITIAL IF CITATION CONSIDERED, WHETHER OR NOT CITATION IS IN CONFORMANCE WITH MPEP 609; DRAW LINE THROUGH CITATION IF NOT IN CONFORMANCE AND NOT CONSIDERED, INCLUDE COPY OF THIS FORM WITH NEXT COMMUNICATION TO APPLICANT.